

Designator	Comment	Footprint	Part Number	Part Description	Quantity
B1, B2	Plated Hole	MTG420_550	PLATED_HOLE4.2_PAD5.5	Plated Through Hole: Hole Dia.=4.2mm Pad Dia.=5.5mm	2
C1, C2	2.2n	CAPC4532X250N	CC1812_2.2NF_1000V_10%_X7R	SMD Multilayer Chip Ceramic Capacitor	2
F1	0.5A-125V	FUSE_LITTELFUSE_0154	FUSE_LITTELFUSE_0154.500DR	SMF OMNI-BLOK® Very Fast-Acting Fuse and Holder	1

A

B

C

D

E

1

1

2

2

3

3

4

4

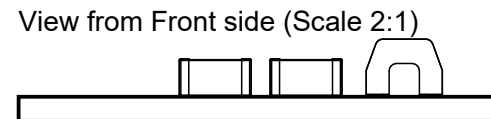
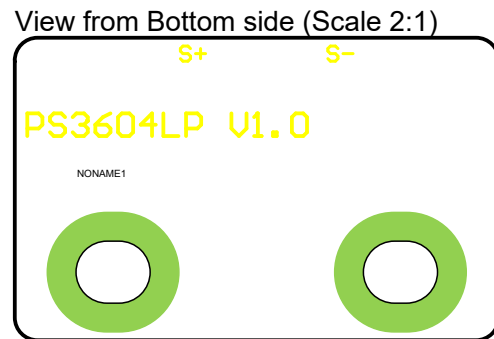
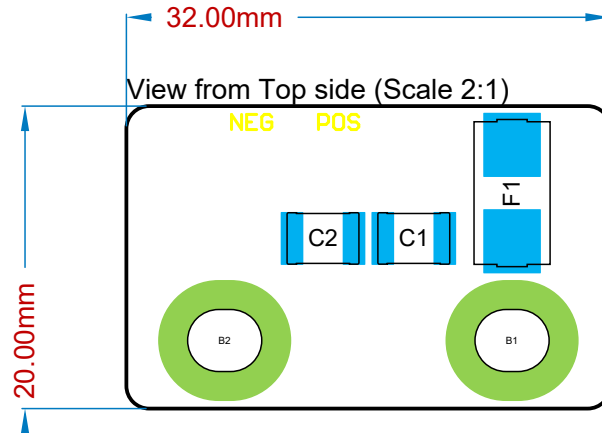
A

B

C

D

E



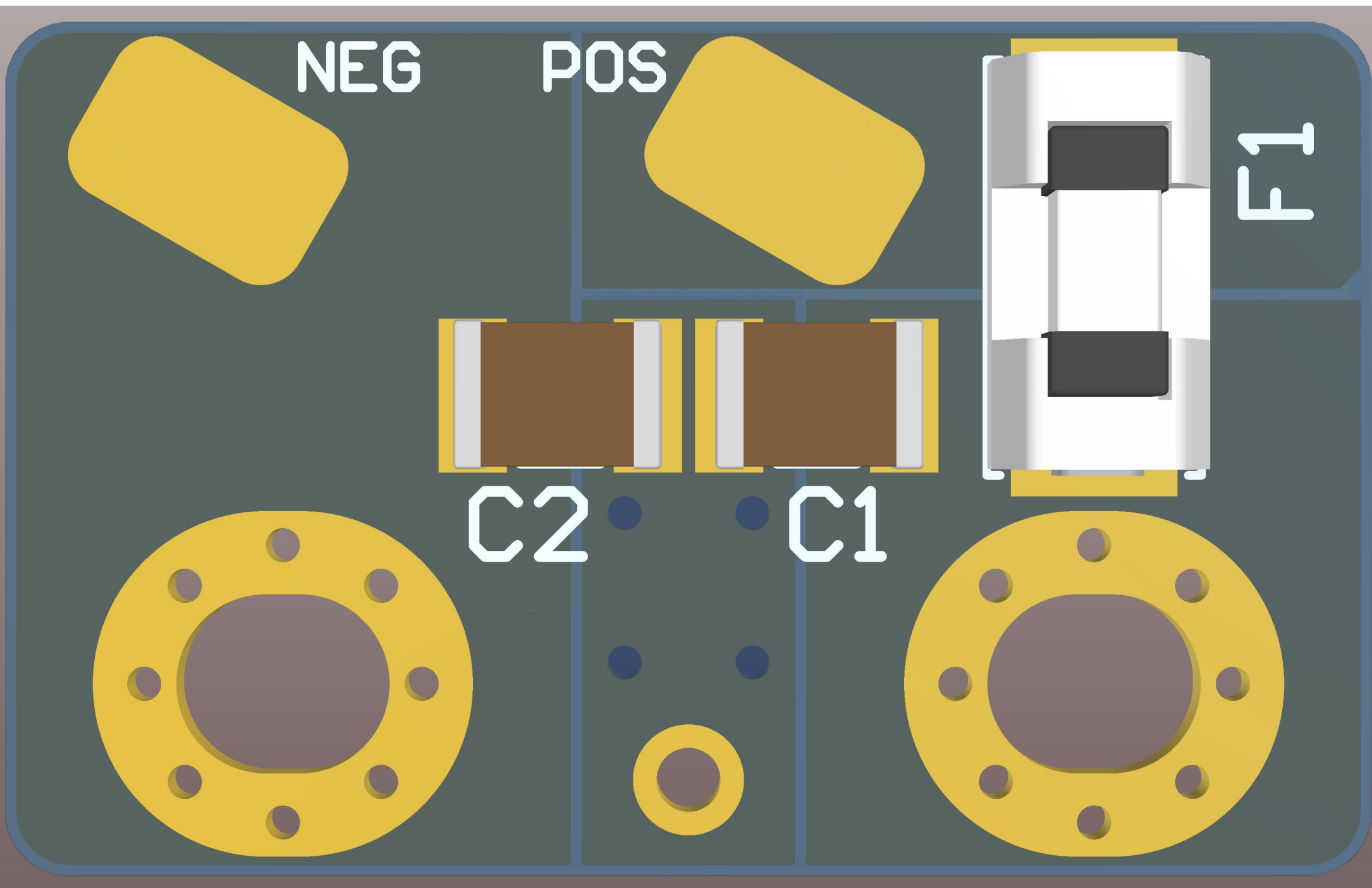
NEG

POS

E1

C2

C1



S+

S-

PS3604LP

V1.0



DEL

